AMENDMENTS TO THE CLAIMS

The following listing of claims will replace all prior versions and listings of claims in the application.

LISTING OF CLAIMS

1. (Currently Amended) A method of manufacturing a display structure, comprising the steps of:

~~arranging~~ defining at least a display area, an extension area, and an IC mounting area on a display substrate~~;~~, the display substrate constituting a part of one of a liquid crystal device, an organic electro luminescence device, and a plasma device;

connecting a flexible tape substrate to the extension area of the display substrate;

forming a cut substrate by ~~separating a part of the display substrate by~~ cutting the display substrate at a cutting portion ~~which~~ that is ~~a part~~ partially disposed under the flexible tape substrate on the extension area of the display substrate; and

disposing the cut~~a cutting~~ substrate ~~which is the separated part,~~ on a back side of the display substrate, the back side being ~~which is~~ opposite to a front side where the display area is defined. ~~a display is mounted, of the display substrate.~~

2. (Currently Amended) A method of manufacturing a display structure, according to claim 1,

wherein the display substrate comprises~~is~~ a glass substrate,

the IC mounting area is defined on a part of the display substrate that ~~included in the area which~~ is to become the cut substrate~~be the cutting substrate of the display substrate~~, and

~~an~~ a driving integrated circuit ~~for driving~~ is mounted on the IC mounting area by COG bonding before the cutting of the display substrate.

3. (Currently Amended) A method of manufacturing a display structure, according to claim 1, wherein:

before the cutting of the display substrate, ~~the~~ a display is mounted on the display area, the flexible tape substrate is connected to the extension area, and a driving~~the~~ integrated circuit ~~for driving~~ is mounted on the IC mounting area; and

the display, the flexible substrate and the driving integrated circuit are all mounted on a front side of the display substrate~~which is a side where the display is mounted, of the display substrate before the cutting~~.

4. (Original) A method of manufacturing a display structure, according to claim 1, wherein a plurality of parallel wirings is formed on the front side and the extension area of the display substrate before the cutting.

5. (Currently Amended) A method of manufacturing a display structure, according to claim 1, wherein the flexible tape substrate is connected to the extension area of the display substrate in such a manner that one end of the flexible tape substrate is connected to a part of the display substrate which is to become~~be~~ the cut substrate, ~~of the display substrate,~~ and the other end of the flexible tape substrate is connected to another part of the display substrate which is different ~~other~~ than the part which is to become~~be~~ the cut substrate~~, of the display substrate~~.

6. (Original) A method of manufacturing a display structure, according to claim 5,

wherein a plurality of parallel wirings is formed on the flexible tape substrate, and

each wiring on the flexible tape substrate is respectively connected to each wiring on the extension area when the flexible tape substrate is connected to the extension area of the display substrate.

7. (Currently Amended) A method of manufacturing a display structure, according to claim 1, wherein before the cutting of the display substrate, a second flexible tape substrate for external connection is connected to the IC mounting area which is on the front side of the display substrate ~~before the cutting~~.

8. (Currently Amended) A method of manufacturing a display structure, according to claim 1, wherein the flexible tape substrate is in a bent state ~~of bent~~ when the flexible tape substrate is connected to the extension area of the display substrate.

9. (Currently Amended) A method of manufacturing a display structure, according to claim 1, wherein an area ~~of which~~having a width that is at least twice ~~or more of the~~ a thickness of the display substrate is removed from the extension area by the cutting of~~when~~ the display substrate~~ is cut~~.

10. (Currently Amended) A method of manufacturing a display structure, according to claim 1, further comprising the step of cutting a groove at the cutting portion of~~on~~ the display substrate before the cutting of the display substrate,

wherein the cutting of the display substrate is carried out by applying a force that ~~tend to bend~~bends the display substrate~~ on the display substrate~~ after the groove is formed.

11. (Currently Amended) A method of manufacturing a display structure, according to claim 4, further comprising the steps of:

forming terminals on the wirings on the extension area of the display substrate; and

inspecting a circuit operation by using the terminals before the cutting of the display substrate.

12. (Original) A method of manufacturing a display structure, according to claim 4, wherein the wirings on the extension area of the display substrate are formed as transparent electrodes.

13. (Currently Amended) A method of manufacturing a display structure, according to claim 10, wherein the groove is formed by using a laser.

14-15. (Cancelled)